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Form PTO-1595

ЭМВ No. 0651-0011 (exp. 4/94)

To the Honorable Commissioner of Patents and Trademarks. Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Ulrich Krumbein Hans Taddikem

o(a) of conveying porty(ies) attached? [ ] Ves [ X ] No

2. Name and address of receiving party(ies): Name: Infineon Technologies AG

Street Address: St. Martin-Strasse 53

City: 81669 München

Country: Germany

Additional name(s) & address(es) attached? []Yes [X] No

Additional frame(s) of conveying part	y(ics) attached: [ ] Tes [ 71 ] Te
3. Nature of Conveyance:	
[X] Assignment [] Security Agreement [] Other	[ ] Merger [ ] Change of Name
Execution Date(s): May 27	, 2004, May 28, 2004

4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is

A. Patent Application No(s) 10/769,458

B. Patent No(s)

Additional numbers attached? [ ] Yes [X] No Title of Invention: Semiconductor Structure with Field Plate

Our Docket No.: 1890-0050

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Harold C. Moore

Internal Address: Maginot, Moore & Beck

Street Address: 111 Monument Circle, Suite 3000 City: State: Zip: Indianapolis, IN 46204-5115

6. Total number of applications and patents involved

7. Total fee (37 CFR 3.41): .\$ 40.00

[X] Enclosed

[ ] Authorized to be charged to deposit account

8. Deposit Account number: 13-0014

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and Fue copy of the original document. correct and any attached copy is

Harold C. Moore Name of Person Signing Registration No. 37,892

August 16, 2004 Signature

Date

Total number of pages including cover sheet, attachments and document 3

Mail documents to be recorded with required cover sheet information to: Mail Stop Assignment Recordation Services, Commissioner for Patents P.O. Box 1450, Alexandria, VA 22313-1450

68/20/2004 NAMED1 00000051 10769458

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## ASSIGNMENT

For good and valuable consideration, I, Ulrich Krumbein, a citizen of Germany, residing at Kaltwiesstraße 35, 83026 Rosenheim, Germany, and Hans Taddiken, a citizen of Germany, residing at Sandgrubenweg 144, 81737 München, Germany, hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to Infineon Technologies AG, a corporation organized and existing under the laws of Germany, having its principal place of business at St. Martin Str. 53, 81669, Munich, Germany, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and

filed on Jan	uary 30, 2004	US. Serial No. <u>10/769,458</u>
entitled:	SEMICONDUCTOR STR	RUCTURE WITH FIELD PLATE

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements an the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, it successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE:	u.len Sei	DATE: 27.05.7004
	NAME: Ulrich Krumbein	
SIGNATURE:	NAME: Hans Taddiken	DATE:

## **ASSIGNMENT**

For good and valuable consideration, I, Ulrich Krumbein, a citizen of Germany, residing at Kaltwiesstraße 35, 83026 Rosenheim, Germany, and Hans Taddiken, a citizen of Germany, residing at Sandgrubenweg 144, 81737 München, Germany, hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to Infineon Technologies AG, a corporation organized and existing under the laws of Germany, having its principal place of business at St. Martin Str. 53, 81669, Munich, Germany, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and

which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and
filed on <u>January 30, 2004</u> US. Serial No. <u>10/769,458</u> ,
entitled: SEMICONDUCTOR STRUCTURE WITH FIELD PLATE
and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;
Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements an the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and
Covenant with said Assignee, it successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.
SIGNATURE: DATE: NAME: Ulrich Krumbein
SIGNATURE: DATE: 5/28/04

PATENT REEL: 015709 FRAME: 0781

NAME: Hans Taddiken

RECORDED: 08/19/2004